

CLAIMS:

- 5 What is claimed is:
1. A coil bobbin comprising:
 a housing having a floor with at least one electrical lead-in projecting therethrough
 for attachment to a printed circuit board, said at least one electrical lead-in being provided
10 with thermal-strain relief between said floor and said printed circuit board.
 2. The coil bobbin of Claim 1 wherein said thermal-strain relief comprises at least one
 loop formed in said electrical lead-in.
- 15 3. The coil bobbin of Claim 2 wherein said loop comprises a U-shaped portion.
4. The coil bobbin of Claim 2 wherein said loop comprises an O-shaped portion.